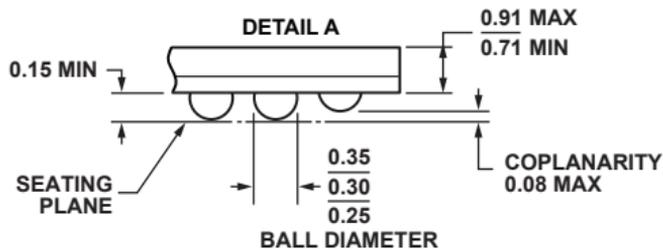
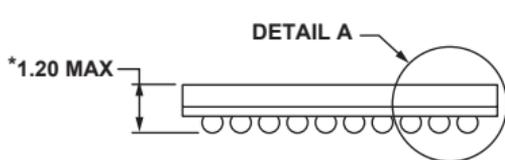
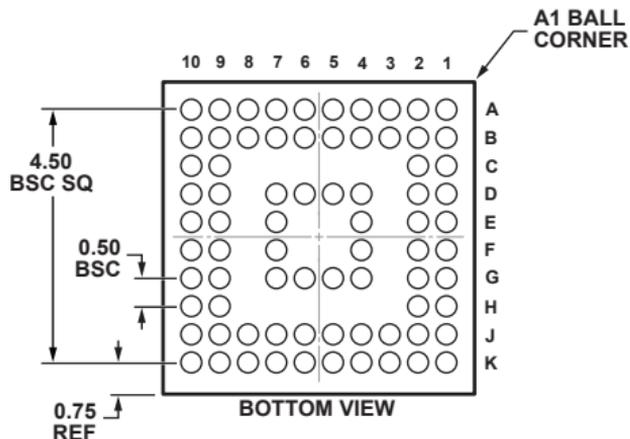
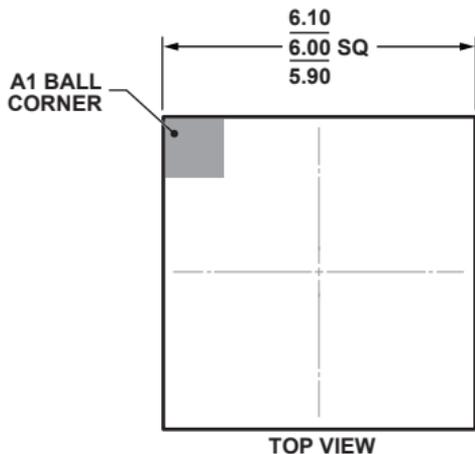


**76-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-76-2)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-225 (NO EXACT VARIATION)
AND WITH THE EXCEPTION TO PACKAGE HEIGHT.